

Supporting Information

Synergistic Improvement of Sensing Performance in Ferroelectric-Based Gas Sensors Using Remnant Polarization

Wonjun Shin, Jiyong Yim, Jong-Ho Bae, Jung-Kyu Lee, Jaehyeon Kim, Seongbin Hong, Yujeong Jeong, Dongseok Kwon, Gyuweon Jung, Changhyeon Han, Jeonghan Kim, Byung-Gook Park, Daewoong Kwon, and Jong-Ho Lee**

W. Shin, J. K. Lee, J. Kim, S. Hong, Y. Jeong, D. Kwon, G. Jung, B. G. Park, J. H. Lee
Department of Electrical and Computer Engineering and Inter-University Semiconductor
Research Center (ISRC), Seoul National University, Seoul 08826, Korea
E-mail: jhl@snu.ac.kr

J. Yim, C. Han, J. Kim, D. Kwon
Department of Electrical Engineering, Inha University, Incheon, Korea.
E-mail: dw79kwon@inha.ac.kr

J. H. Bae
School of Electrical Engineering, Kookmin University, Seoul 02707, Korea

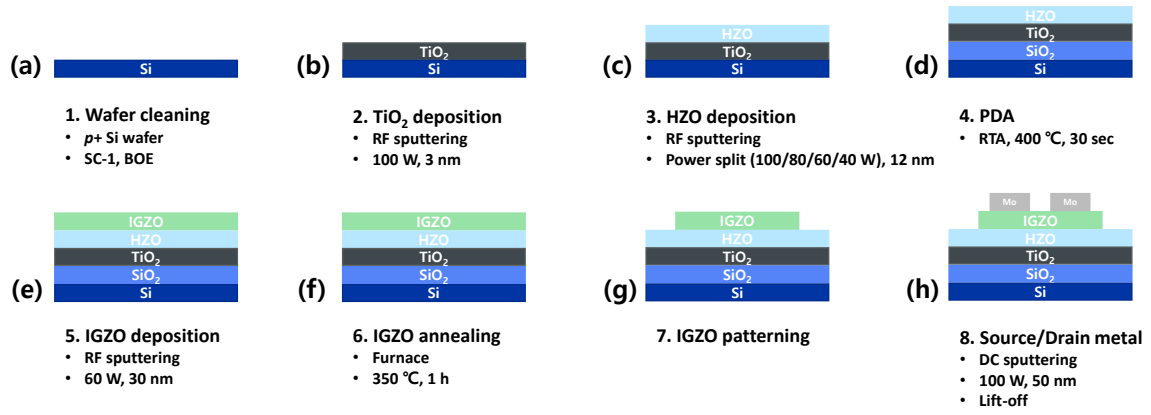


Figure S1. Fabrication process flow of the IGOZ FeTFT gas sensors. (a) Wafer cleaning. (b) TiO₂ deposition. (c) HZO deposition. (d) Post-deposition annealing (PDA). (e) IGZO deposition. (f) IGZO annealing. (g) IGZO patterning. (h) Source/drain metal formation.

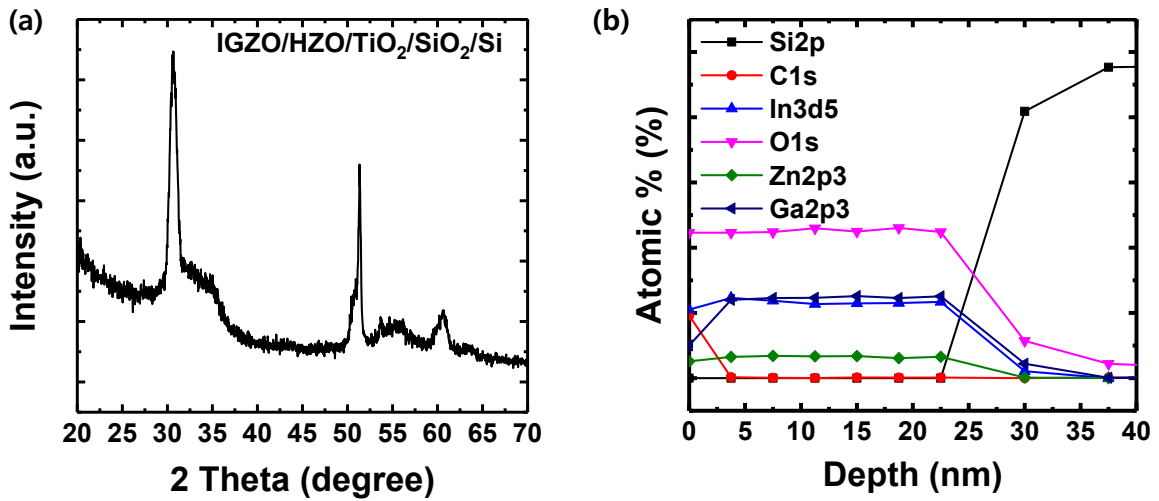


Figure S2. (a) X-ray diffractograms and (b) EDS line scan of the IGZO film.

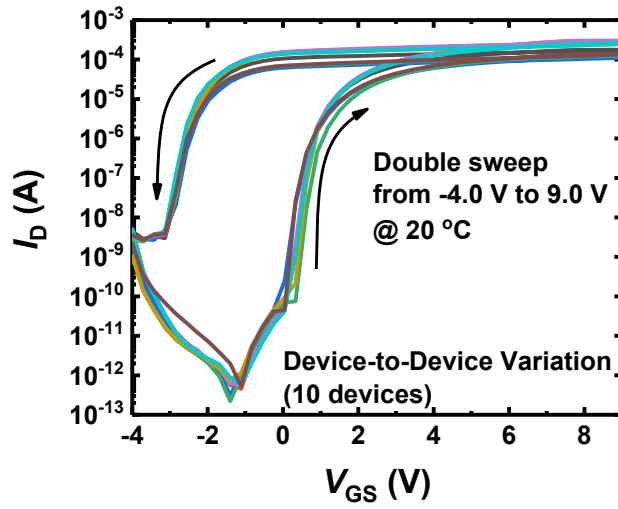


Figure S3. Device-to-device variation of the fabricated FeTFT gas sensors. Transfer characteristics (I_D - V_{BG}) are measured at 10 independent samples of the FeTFT gas sensors. The V_{GS} is double-swept from -4.0 V to 9.0 V with a drain voltage of 1.0 V.

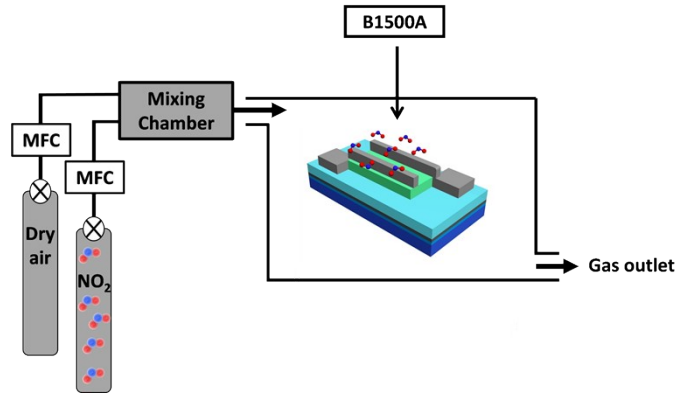


Figure S4. Schematic diagrams of gas sensing measurement system. Gas sensing characteristics of the sensors are analyzed by using a semiconductor parameter analyzer (B1500A) and the probe station that contains a test chamber, chuck, gas inlet, and outlet. NO_2 gas is used as a target gas and gas flow is controlled by a mass flow controller (MFC). The operating temperature of the sensing material in the sensor is set to 150 °C by an external heater. The target gas is mixed with dry air with a relative humidity of 4% for controlling the gas concentration and then the gas is injected into the test chamber.

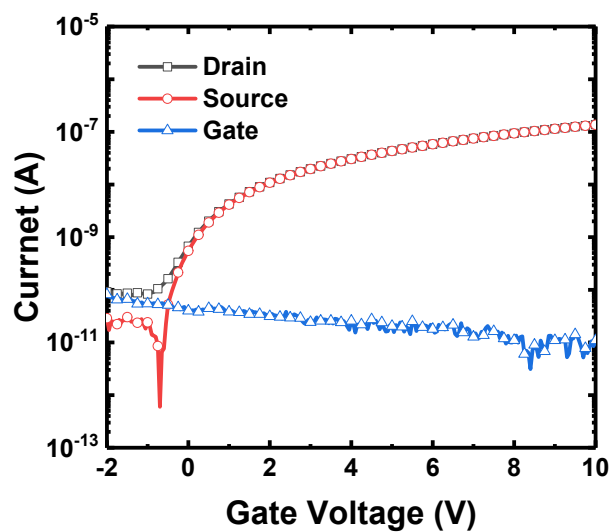


Figure S5. Drain, source, and gate currents versus V_{BG} of the reference TFT gas sensor measured at 20 °C.

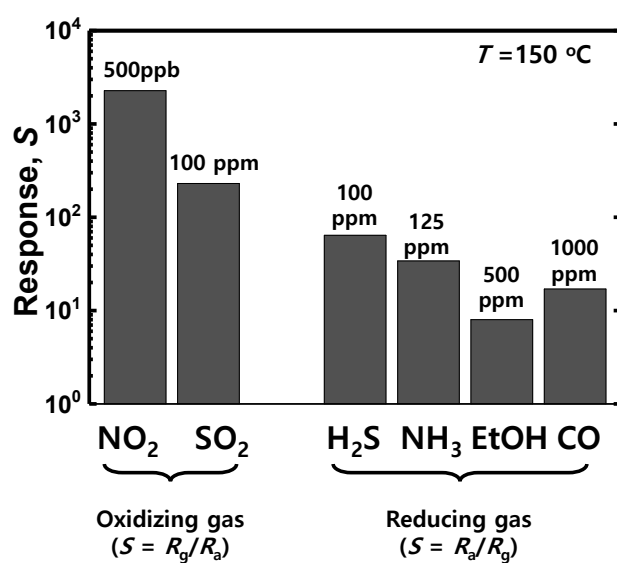


Figure S6. Response of the FeTFT gas sensor to NO₂, SO₂, H₂S, NH₃, EtOH, and CO gases (NO₂ 500 ppb, H₂S 100 ppm, H₂S 100 ppm, NH₃ 125 ppm, EtOH 500 ppm, and CO 1000 ppm).

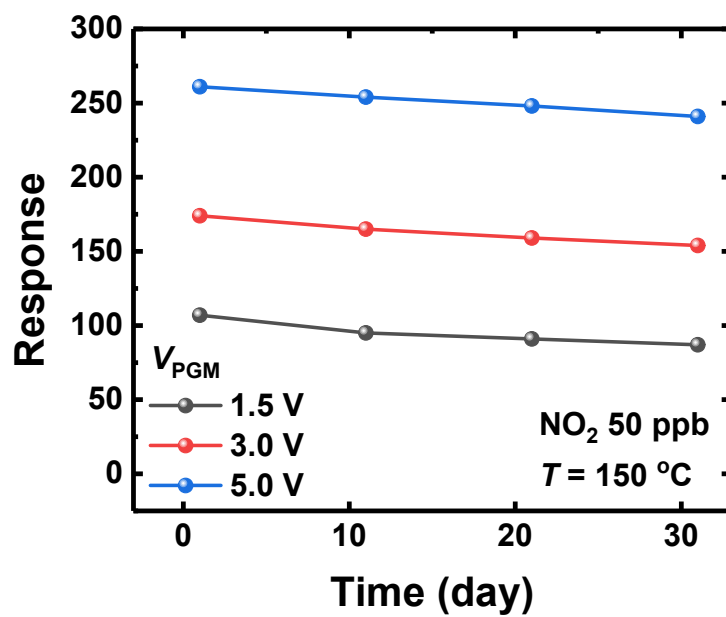


Figure S7. Response of the FeTFT gas sensor to 50 ppb of NO_2 gas over time as a parameter of V_{PGM} . The response is measured under different V_{PGM} s at $150\text{ }^\circ\text{C}$ for 30 days. The sensor shows a slight decrease in the response after 30 days. Further research is required to determine the exact mechanism of such degradation.

Table S1. Comparison of this work with previous NO₂ gas sensors.

Sensing material	Sensor platform	Response to NO ₂ 500 ppb	Operating temperature	Tunability	Ref.
Au-loaded Tellurium	Resistor-type	5.2	180 °C	N/A	[1]
In ₂ O ₃ -ZnO	Resistor-type	33	RT (UV irradiation)	N/A	[2]
MoS ₂	Resistor-type	5.2	RT	N/A	[3]
MoS ₂	Resistor-type	31	RT (Illumination)	N/A	[4]
WO ₃	Resistor-type	4.3	150 °C	N/A	[5]
In ₂ O ₃	FET-type	8.2	172 °C	N/A	[6]
WS ₂ -IGZO	TFT-type	10.2	150 °C	N/A	[7]
IGZO	FET-type	2.14	150 °C	N/A	[8]
IGZO	TFT-type	2272	150 °C	Y (Polarization)	This work (FeTFT)

References

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